



SJMOS N-MOSFET 600V, 70mΩ, 39A

Features

- CRM(CQ) Super_Junction technology
- Much lower Ron*A performance for On-state efficiency
- Better efficiency due to very low FOM
- Ultra-fast body diode
- Qualified for industrial grade applications according to JEDEC

Applications

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply

Product Summary

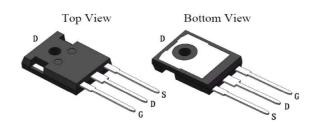
$V_{DS,min}$	600V
$R_{DS(on),typ}$	70mΩ
I_{D}	39A

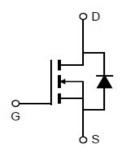
100% DVDS Tested

100% Avalanche Tested









Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRJQ74N60G2BF	CRJQ74N60G2BF	TO-247-3L	Tube	N/A	N/A	25pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	600	V
Continuous drain current 1)			
$T_C = 25$ °C	\mathbf{I}_{D}	39	Α
$T_{C} = 100^{\circ}C$		25	
Pulsed drain current $^{2)}$ (T _C = 25°C, t _p limited by T _{j,max})	${ m I}_{ m D,pulse}$	118	Α
Avalanche energy, single pulse (L=30mH)	E _{AS}	520	mJ
MOSFET dv/dt ruggedness	dv/dt	50	V/ns
Gate-Source voltage	V_{GS}	±30	V
Power dissipation ($T_C = 25^{\circ}C$)	P _{tot}	319	W
Continuous diode forward current($T_C = 25$ °C)	I_{S}	39	А
Diode pulse current $^{2)}$ (T _C = 25°C)	$I_{S,pulse}$	118	А
Recovery diode dv/dt ³⁾	dv/dt	50	V/ns
Operating junction and storage temperature	T_{j} , T_{stg}	-55+150	°C

¹⁾ Limited by $T_{\rm j,max}.$ Maximum Duty Cycle D = 0.50 $\,$

²⁾ Pulse width t_p limited by T_{i,max}

³⁾ Identical low side and high side switch with identical $\boldsymbol{R}_{\boldsymbol{g}}$





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Thermal Resistance

Parameter	Symbol	Value			Unit	Test Condition
Parameter	Symbol	min.	typ.	max.	Oilit	rest condition
Thermal resistance, junction – case	R _{thJC}	-	0.28	0.39	°C/W	
Thermal resistance, junction – ambient	R _{thJA}	-	-	48	°C/W	

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified) Value

Parameter	Cymphal	Value			Unit	Test Condition		
	Symbol	min.	typ.	max.	Oilit	rest condition		
Static Characteristic								
Drain-source breakdown voltage	BV_{DSS}	600	-	-	V	V_{GS} =0V, I_D =250 μ A		
Gate threshold voltage	$V_{GS(th)}$	3.2	-	4.6	V	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$		
Zero gate voltage drain current	${ m I}_{ m DSS}$	-	- 500	5	μΑ	V_{DS} =600V, V_{GS} =0V T_{j} =25°C T_{j} =150°C		
Gate-source leakage current	${ m I}_{ m GSS}$	-	-	±100	nA	V_{GS} =±30V, V_{DS} =0V		
Drain-source on-state resistance	R _{DS(on)}	-	70 180	77 -	mΩ	$V_{GS}=10V, I_{D}=23A,$ $T_{j}=25^{\circ}C$ $T_{j}=150^{\circ}C$		
Transconductance	g _{fs}	-	30	-	S	V _{DS} =20V,I _D =23A		

Dynamic Characteristic

Input Capacitance	C _{iss}	-	2200	-		
Output Capacitance	C _{oss}	-	137	-	pF	V_{GS} =0V, V_{DS} =100V, f=1MHz
Reverse Transfer Capacitance	C _{rss}	-	3.2	-		
Gate Total Charge	Q _g	-	84	-		
Gate-Source charge	Q_{gs}	-	19	-	nC	V_{GS} =10V, V_{DS} =480V, I_{D} =23A
Gate-Drain charge	Q_{gd}	-	53	-	V	
Gate plateau voltage	$V_{plateau}$	-	7.5	-		
Turn-on delay time	t _{d(on)}	-	63	-		
Rise time	t _r	-	107	-		V_{GS} =10V, I_{D} =23A, V_{DS} =400V, R_{g} =27 Ω
Turn-off delay time	t _{d(off)}	-	244	-	ns	
Fall time	t _f	-	103			
Gate resistance	$R_{g,int}$	-	1.2	-	Ω	f=1MHz



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Body Diode Characteristic

Parameter	Symbol				Unit	Test Condition	
	Syllibol	min.	typ.	max.	Oilit	rest condition	
Body Diode Forward Voltage	V _{SD}	0.7	0.91	1.1	V	$V_{GS}=0V,I_{SD}=23A$	
Body Diode Reverse Recovery Time	t _{rr}	-	125	-	ns	I _{SD} =23Α di _F /dt=100Α/μs	
Body Diode Reverse Recovery Charge	Q _{rr}	-	0.9	-	μC	V _{DS} =400V	



Typical Performance Characteristics

Fig 1. Output Characteristics $(T_j=25^{\circ}C)$

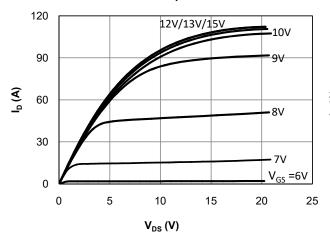


Fig 2. Output Characteristics (T_i=150℃)

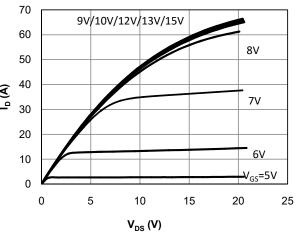


Fig 3: Transfer Characteristics

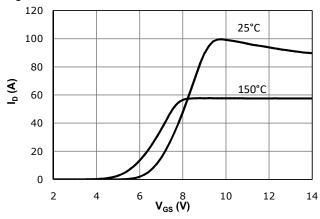


Fig 4: V_{TH} vs. T_i Temperature Characteristics

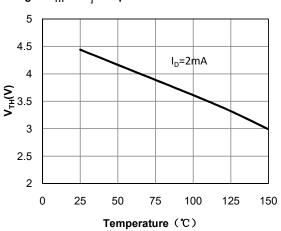


Fig 5: $R_{DS(on)}$ vs. I_{DS} Characteristics(T_j =25 $^{\circ}$ C)

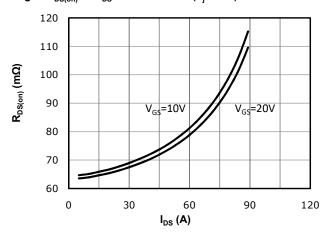


Fig 6: R_{DS(on)} vs. Temperature

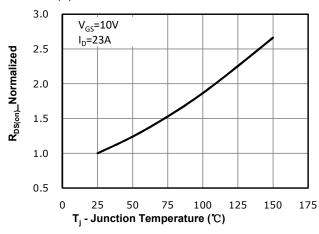




Fig 7: BV_{DSS} vs. Temperature

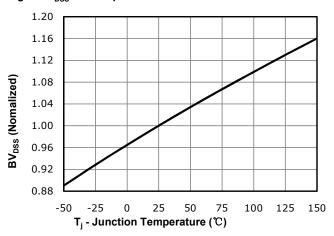


Fig 8: $R_{\rm DS(on)}$ vs. Gate Voltage

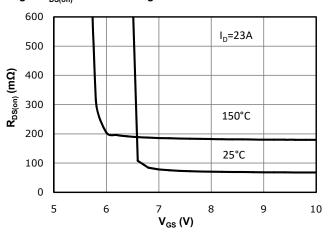


Fig 9: Body-diode Forward Characteristics

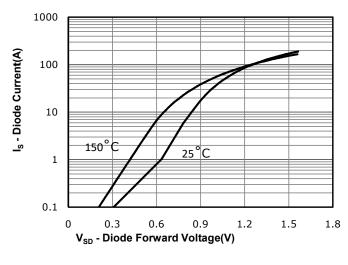


Fig 10: Gate Charge Characteristics

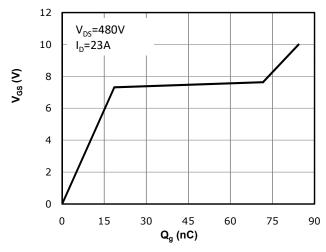


Fig 11: Capacitance Characteristics

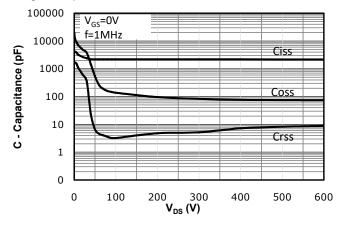
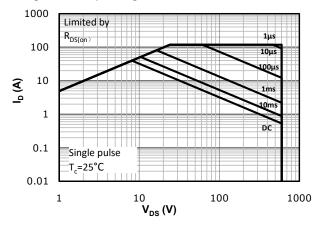
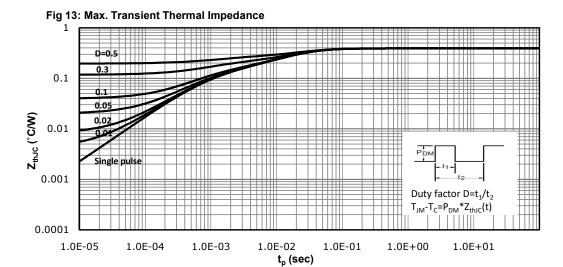


Fig 12: Safe Operating Area

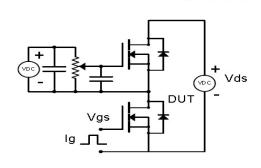


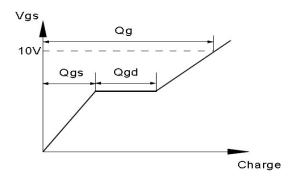




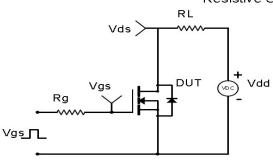
Test Circuit & Waveform

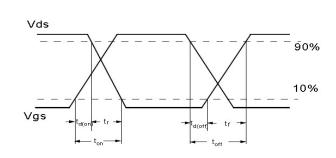
Gate Charge Test Circuit & Waveform



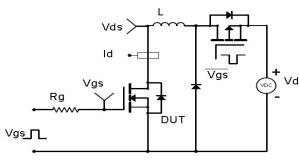


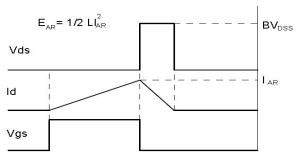
Resistive Switching Test Circuit & Waveforms



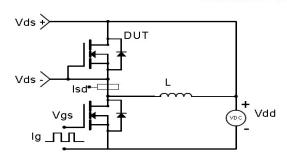


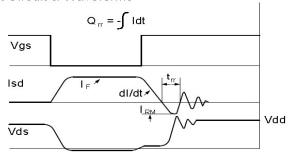
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





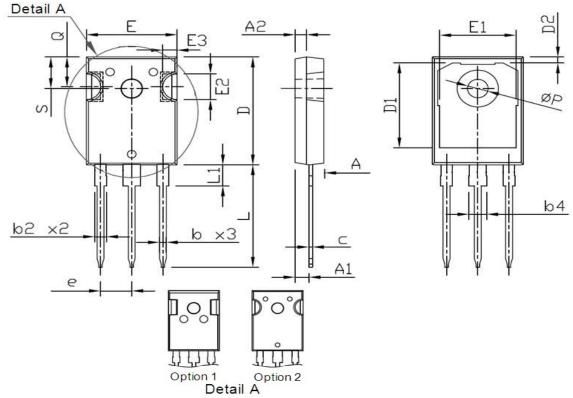
Diode Recovery Test Circuit & Waveforms







Package Outline: TO-247-3L



Comple of	Dimensions In	Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	4.70	5.30	0.185	0.209
A1	2.20	2.60	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	1.04	1.33	0.041	0.052
b2	1.90	2.41	0.075	0.095
b4	2.87	3.43	0.113	0.135
С	0.55	0.70	0.022	0.028
D	20.70	21.30	0.815	0.839
D1	16.25	17.65	0.640	0.695
D2	0.51	1.40	0.020	0.055
е	5.44 BS	SC.	0.21	4 BSC.
Е	15.50	16.30	0.610	0.642
E1	13.08	14.16	0.515	0.557
E2	3.80	5.49	0.150	0.216
E3	1.00	2.75	0.039	0.108
L	19.72	20.32	0.776	0.800
L1	3.85	4.50	0.152	0.177
Q	5.25	6.25	0.207	0.246
Р	3.50	3.70	0.138	0.146
S	6.04	6.30	0.238	0.248



Marking



NOTE:

NXBBAAAA

N —WB code (Usually omitted)
X —Assembly location code

BB —Fab code AAAA —Lot code



CRJQ74N60G2BF

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Revision His	story	
Revison	Date	Major changes
1.0	2023/11/30	First version

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qulified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semicondutor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.